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### LM34 Precision Fahrenheit Temperature Sensors

Technical

Documents

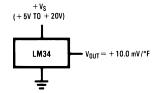
#### 1 Features

- Calibrated Directly in Degrees Fahrenheit
- Linear 10.0 mV/°F Scale Factor
- 1.0°F Accuracy Assured (at 77°F)
- Rated for Full -50° to 300°F Range
- Suitable for Remote Applications
- Low Cost Due to Wafer-Level Trimming
- Operates From 5 to 30 Volts
- Less Than 90-µA Current Drain
- Low Self-Heating, 0.18°F in Still Air
- Nonlinearity Only ±0.5°F Typical
- Low-Impedance Output, 0.4 Ω for 1-mA Load

#### Applications 2

- **Power Supplies**
- **Battery Management**
- HVAC
- Appliances

#### Basic Fahrenheit Temperature Sensor (5°F to 300°F)



#### 3 Description

Tools &

Software

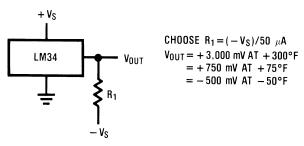
The LM34 series devices are precision integratedcircuit temperature sensors, whose output voltage is linearly proportional to the Fahrenheit temperature. The LM34 device has an advantage over linear temperature sensors calibrated in degrees Kelvin, because the user is not required to subtract a large constant voltage from its output to obtain convenient Fahrenheit scaling. The LM34 device does not require any external calibration or trimming to provide typical accuracies of ±1/2°F at room temperature and ±1-1/2°F over a full -50°F to 300°F temperature range. Lower cost is assured by trimming and calibration at the wafer level. The low output impedance, linear output, and precise inherent calibration of the LM34 device makes interfacing to readout or control circuitry especially easy. It can be used with single power supplies or with plus and minus supplies. Because the LM34 device draws only 75 µA from its supply, the device has very low selfheating, less than 0.2°F in still air.

The LM34 device is rated to operate over a -50°F to 300°F temperature range, while the LM34C is rated for a -40°F to 230°F range (0°F with improved accuracy). The LM34 devices are series is available packaged in hermetic TO-46 transistor packages; while the LM34C, LM34CA, and LM34D are available in the plastic TO-92 transistor package. The LM34D device is available in an 8-lead, surface-mount, smalloutline package. The LM34 device is a complement to the LM35 device (Centigrade) temperature sensor.

Device Information <sup>(1)</sup>							
PART NUMBER PACKAGE BODY SIZE (NOM)							
	SOIC (8)	4.90 mm × 3.91 mm					
LM34	TO-92 (3)	4.30 mm × 4.30 mm					
	TO-46 (3)	4.699 mm × 4.699 mm					

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### Full-Range Fahrenheit Temperature Sensor



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#### **4** Revision History

C	hanges from Revision C (January 2015) to Revision D	Page
•	Changed NDV Package (TO-46) pinout from Top View to Bottom View	3
C	hanges from Revision B (November 2000) to Revision C	Page
•	Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and	

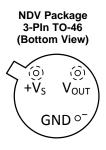
Product Folder Links: LM34



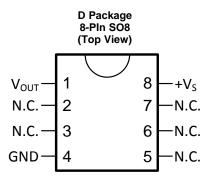
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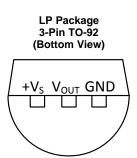
#### 5 Pin Configuration and Functions



Case is connected to negative pin (GND)



N.C. = No connection



#### **Pin Functions**

	PI	N		ТҮРЕ	DESCRIPTION			
NAME	TO46/NDV	TO92/LP	SO8/D	ITPE				
+V <sub>S</sub>	_		8	POWER	Positive power supply pin			
V <sub>OUT</sub>	—	—	1	0	Temperature Sensor Analog Output			
GND	—		4	GND	Device ground pin, connect to power supply negative terminal			
			2					
			3					
N.C.	_	_	5	]	No Connection			
			6					
			7					

#### 6 Specifications

#### 6.1 Absolute Maximum Ratings<sup>(1)(2)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
Supply voltage			-0.2	V
Output voltage		6	-1	V
Output current			10	mA
Storage temperature, T <sub>stg</sub>	TO-46 Package	-76	356	
	TO-92 Package	-76	300	°F
	SO-8 Package	-65	150	

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/ Distributors for availability and

specifications.

#### 6.2 ESD Ratings

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2500	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

#### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
	LM34, LM34A	-50	300	
Specified operating temperature range $(T_{MIN} \le T_A \le T_{MAX})$	LM34C, LM34CA	-40	230	°F
	LM34D	32	212	
Supply Voltage Range (+V <sub>S</sub> )		4	30	V

#### 6.4 Thermal Information

	THERMAL METRIC <sup>(1)</sup>	NDV (TO-46)	LP (TO-92)	D (SO8)	UNIT
		3 PINS	3 PINS	8 PINS	
$R_{\theta J A}$	Junction-to-ambient thermal resistance	720	324	400	°F/W
$R_{\theta JC}$	Junction-to-case thermal resistance	43	—	—	Г/VV

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



#### 6.5 Electrical Characteristics: LM34A and LM34CA

Unless otherwise noted, these specifications apply:  $-50^{\circ}F \le T_J \le 300^{\circ}F$  for the LM34 and LM34A;  $-40^{\circ}F \le T_J \le 230^{\circ}F$  for the LM34C and LM34CA; and  $32^{\circ}F \le T_J \le 212^{\circ}F$  for the LM34D.  $V_S = 5$  Vdc and  $I_{LOAD} = 50 \ \mu\text{A}$  in the circuit of *Full-Range Fahrenheit Temperature Sensor*; 6 Vdc for LM34 and LM34A for  $230^{\circ}F \le T_J \le 300^{\circ}F$ . These specifications also apply from  $5^{\circ}F$  to  $T_{MAX}$  in the circuit of *Basic Fahrenheit Temperature Sensor* ( $5^{\circ}F$  to  $300^{\circ}F$ ).

DADAMETED	TEST CONDITIONS			LM34A		L	UNIT		
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
		Tested Limit <sup>(2)</sup>	-1		1	-1		1	
	T <sub>A</sub> = 77°F	Design Limit <sup>(3)</sup>							°F
				±0.4			±0.4		
		Tested Limit							
	$T_A = 0^{\circ}F$	Design Limit				-2		2	°F
A(1)				±0.6			±0.6		
Accuracy <sup>(1)</sup>		Tested Limit	-2		2	-2		2	
	$T_A = T_{MAX}$	Design Limit							°F
				±0.8			±0.8		
		Tested Limit	-2		2				
	$T_A = T_{MIN}$	Design Limit				-3		3	°F
				±0.8			±0.8		
Nonlinearity <sup>(4)</sup>		Tested Limit							
		Design Limit	-0.7		0.7	-0.6		0.6	°F
	T <sub>A</sub> = 77°F			±0.35			±0.3		
		Tested Limit	9.9		10.1				
Sensor gain (Average Slope)		Design Limit				+9.9		10.1	mV/°F
0.000	T <sub>A</sub> = 77°F			+10			10		
		Tested Limit	-1		1	-1		1	mV/mA
	$T_A = 77^{\circ}F$ 0 ≤ I <sub>L</sub> ≤ 1 mA	Design Limit							
Load regulation <sup>(5)</sup>	0 - 12 - 1 11/2			±0.4			±0.4		
		Tested Limit							
	$0 \le I_L \le 1 \text{ mA}$	Design Limit	-3		3	-3		3	mV/mA
				±0.5			±0.5		
		Tested Limit	-0.05		0.05	-0.05		0.05	
	$\begin{array}{l} T_{A} = 77^{o}F \\ 5 \; V \leq V_{S} \leq 30 \; V \end{array}$	Design Limit							mV/V
Line regulation <sup>(5)</sup>				±0.01			±0.01		
		Tested Limit							
	$5 \text{ V} \leq \text{V}_{\text{S}} \leq 30 \text{ V}$	Design Limit	-0.1		0.1	-0.1		0.1	mV/V
				±0.02			±0.02		

 Accuracy is defined as the error between the output voltage and 10 mV/°F times the device's case temperature at specified conditions of voltage, current, and temperature (expressed in °F).

- (2) Tested limits are specified and 100% tested in production.
- (3) Design limits are specified (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.
- (4) Nonlinearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line over the rated temperature range of the device.
- (5) Regulation is measured at constant junction temperature using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.



#### Electrical Characteristics: LM34A and LM34CA (continued)

Unless otherwise noted, these specifications apply:  $-50^{\circ}F \le T_J \le 300^{\circ}F$  for the LM34 and LM34A;  $-40^{\circ}F \le T_J \le 230^{\circ}F$  for the LM34C and LM34CA; and  $32^{\circ}F \le T_J \le 212^{\circ}F$  for the LM34D.  $V_S = 5$  Vdc and  $I_{LOAD} = 50 \ \mu\text{A}$  in the circuit of *Full-Range Fahrenheit Temperature Sensor*, 6 Vdc for LM34 and LM34A for  $230^{\circ}F \le T_J \le 300^{\circ}F$ . These specifications also apply from 5°F to  $T_{MAX}$  in the circuit of *Basic Fahrenheit Temperature Sensor* (5°F to  $300^{\circ}F$ ).

DADAMETED				LM34A		L	.M34CA		UNIT	
PARAMETER	TEST CONDITIONS			TYP	MAX	MIN	TYP	MAX	UNIT	
		Tested Limit			90			90	μA	
	V <sub>S</sub> = 5 V, T <sub>A</sub> = 77°F	Design Limit								
				75		75				
		Tested Limit								
	V <sub>S</sub> = 5 V	Design Limit			160			139	μΑ	
Quiescent current <sup>(6)</sup>				131			116			
		Tested Limit			92			92		
	$V_{S} = 30 \text{ V}, \text{ T}_{A} = 77^{\circ}\text{F}$	Design Limit							μA	
				76			76			
	V <sub>S</sub> = 30 V	Tested Limit							μΑ	
		Design Limit			163			142		
				132			117			
	$4 \text{ V} \leq \text{V}_{\text{S}} \leq 30 \text{ V}, \text{ T}_{\text{A}} = 77^{\circ}\text{F}$	Tested Limit			2			2		
		Design Limit							μA	
Change of quiescent				0.5			0.5			
current <sup>(5)</sup>		Tested Limit							μA	
	$5 \text{ V} \leq \text{V}_{\text{S}} \leq 30 \text{ V}$	Design Limit			3			3		
				1			1			
		Tested Limit								
Temperature coefficient of guiescent current		Design Limit			0.5			0.5	µA/°F	
or quiescent current				0.3			0.3			
	In circuit of Basic Fahrenheit	Tested Limit								
Minimum temperature for rated accuracy	Temperature Sensor (5°F to $300°F$ ), $I_L = 0$	Design Limit			5			5	°F	
rated accuracy	$T_{A} = 77^{\circ}F$			3			3			
Long-term stability	$T_J = T_{MAX}$ for 1000 hours			±0.16			±0.16		°F	

(6) Quiescent current is defined in the circuit of Basic Fahrenheit Temperature Sensor (5°F to 300°F).



#### 6.6 Electrical Characteristics: LM34, LM34C, and LM34D

Unless otherwise noted, these specifications apply:  $-50^{\circ}F \le T_J \le 300^{\circ}F$  for the LM34 and LM34A;  $-40^{\circ}F \le T_J \le 230^{\circ}F$  for the LM34C and LM34CA; and  $+32^{\circ}F \le T_J \le 212^{\circ}F$  for the LM34D.  $V_S = 5$  Vdc and  $I_{LOAD} = 50 \ \mu\text{A}$  in the circuit of *Full-Range Fahrenheit Temperature Sensor*; 6 Vdc for LM34 and LM34A for  $230^{\circ}F \le T_J \le 300^{\circ}F$ . These specifications also apply from 5°F to  $T_{MAX}$  in the circuit of *Basic Fahrenheit Temperature Sensor* (5°F to  $300^{\circ}F$ ).

$\begin{tabular}{ c c c c c c c } & $1$ &$	UNIT
$ \begin{tabular}{ c c c c c } & $$ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $ $$	•
$ \begin{tabular}{ c c c c } & $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$	2
$ \begin{tabular}{ c c c c c } Accuracy, LM34, \\ $$ IM34C^{(1)}$ Max $$ Image $$ Im$	°F
Accuracy, LM34, LM34C <sup>(1)</sup> $T_A = 0^{\circ}F$ Design Limit        3 $T_A = T_{MAX}$ Tested Limit        3         3 $T_A = T_{MAX}$ Tested Limit        3         3 $T_A = T_{MAX}$ Tested Limit        3         -3 $T_A = T_{MIN}$ Tested Limit        3         -3 $T_A = 77^{\circ}F$ Design Limit        3         -3 $T_A = 77^{\circ}F$ Tested Limit        3         -3 $T_A = T_{MAX}$ Tested Limit        4         -4 $T_A = T_{MIN}$ Tested Limit         -9.8         10 $T_A = T_{MIN}$ <td< td=""><td></td></td<>	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	3 °F
$ \begin{tabular}{ c c c c c } \label{eq:LM34C} (1) & $$T_{A} = T_{MAX}$ & $$Tested Limit & $$-3$ & $$3$ & $$-4$ & $$$-3$ & $$$$$$$$$$$$$$$$$$$$$$$$$$$$	
$\begin{tabular}{ c c c c c } \hline & & & & & & & & & & & & & & & & & & $	
$\begin{tabular}{ c c c c c } \hline $T_{A} = $T_{MIN}$ & $Tested Limit$ & $-3$ & $3$ & $-4$ & $$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	3 °F
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$ \begin{array}{ c c c c c c } \hline \begin time time time time time time time time$	4 °F
$ \begin{tabular}{ c c c c c c } & $T_A = 77^\circ F$ & $Design Limit$ & $1$	
$ \begin{array}{ c c c c c c } \mbox{Accuracy, LM34D}^{(1)} & $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$	3
$ \begin{tabular}{ c c c c c } \hline Accuracy, LM34D^{(1)} & $$I_A = T_{MAX}$ & $$Tested Limit $$ $Iested Limit$	°F
Accuracy, LM34D <sup>(1)</sup> $T_A = T_{MAX}$ Design Limit        4 $T_A = T_{MIN}$ Tested Limit        4 $T_A = T_{MIN}$ Tested Limit        4           Nonlinearity <sup>(4)</sup> Tested Limit        4           Nonlinearity <sup>(4)</sup> Tested Limit        4           Sensor gain (Average Slope)         Tested Limit         -1.0         1           Tested Limit         -1.0         1         -1           Tested Limit         9.8         10.2         -1.0           Ta = 77°F         Tested Limit         -2.5         2.5	_
$ \begin{array}{ c c c c c c } \hline & & & & & & & & & & & & & & & & & & $	_
$ \begin{array}{ c c c c c c } \hline & & & & & & & & & & & & & & & & & & $	4°F
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	_
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	
Image: Monitor of the system         Tested Limit $\pm 1.8$ Nonlinearity <sup>(4)</sup> Tested Limit $-1.0$ $1$ $-1$ Design Limit $-1.0$ $1$ $-1$ $1$ Sensor gain (Average Slope)         Tested Limit $9.8$ $10.2$ $10$ T <sub>A</sub> = 77°F         Tested Limit $-2.5$ $2.5$ $-2.5$	4 °F
Nonlinearity (4)         Design Limit         -1.0         1         -1           Sensor gain (Average Slope)         Tested Limit         9.8         10.2         10         10           T_A = 77°F         Tested Limit         -2.5         2.5         -2.5         10	_
Image: Sensor gain (Average Slope)         Tested Limit $\pm 0.6$ $\pm 0.4$ Tested Limit         9.8         10.2           Design Limit         9.8         10           T_A = 77°F         Tested Limit         -2.5         2.5	
Image: Sensor gain (Average Slope)         Tested Limit $\pm 0.6$ $\pm 0.4$ Tested Limit         9.8         10.2           Design Limit         9.8         10           T_A = 77°F         Tested Limit         -2.5         2.5	1 °F
Sensor gain (Average Slope)         Design Limit         9.8         1 $T_A = 77^\circ F$ Tested Limit         -2.5         2.5         -2.5	_
Slope)         Image: Topological state	_
T <sub>A</sub> = 77°F         Tested Limit         -2.5         2.5	2 mV/°F
	_
	5
	mV/mA
±0.4 ±0.4	
Load regulation <sup>(5)</sup> Tested Limit	_
$T_{MIN} \le T_A \le 150^{\circ}F$ Design Limit -6.0 6 -6	6 mV/mA
$0 \le I_L \le 1 \text{ mA}$ $\pm 0.5$ $\pm 0.5$	-
Tested Limit -0.1 0.1 -0.1	1
$T_A = 77^{\circ}F$ , 5 V $\leq$ VS $\leq$ 30 VDesign Limit	mV/V
+0.01 +0.01	-
Line regulation <sup>(5)</sup> Tested Limit	-
	2 mV/V
±0.02 ±0.02	

(1) Accuracy is defined as the error between the output voltage and 10 mV/°F times the device's case temperature at specified conditions of voltage, current, and temperature (expressed in °F).

(2) Tested limits are specified and 100% tested in production.

(5) Regulation is measured at constant junction temperature using pulse testing with a low duty cycle. Changes in output due to heating effects can be computed by multiplying the internal dissipation by the thermal resistance.

<sup>(3)</sup> Design limits are specified (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.

<sup>(4)</sup> Nonlinearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line over the rated temperature range of the device.



#### Electrical Characteristics: LM34, LM34C, and LM34D (continued)

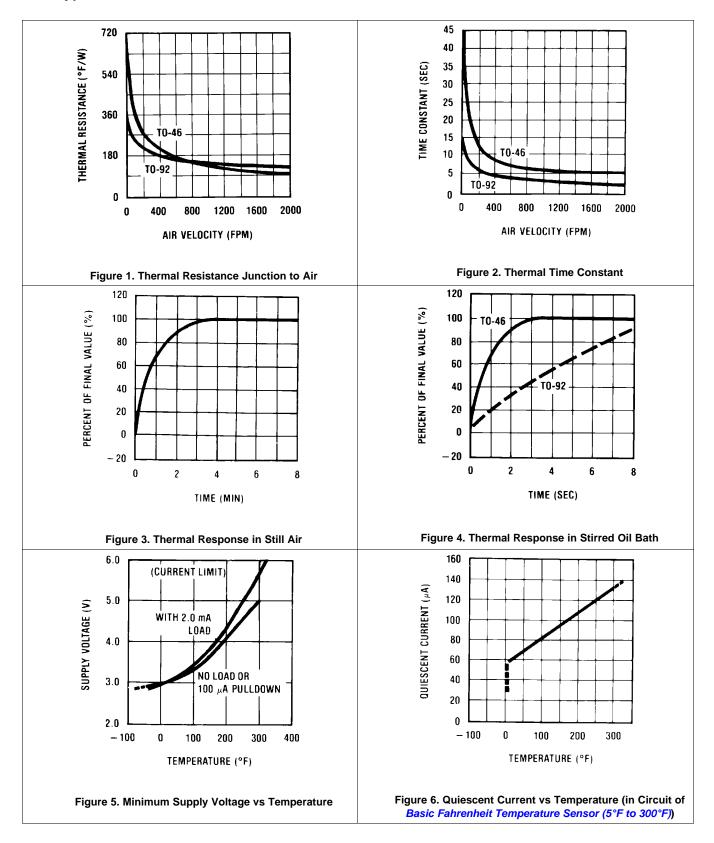
Unless otherwise noted, these specifications apply:  $-50^{\circ}F \le T_{J} \le 300^{\circ}F$  for the LM34 and LM34A;  $-40^{\circ}F \le T_{J} \le 230^{\circ}F$  for the LM34C and LM34CA; and  $+32^{\circ}F \le T_{J} \le 212^{\circ}F$  for the LM34D.  $V_{S} = 5$  Vdc and  $I_{LOAD} = 50 \ \mu\text{A}$  in the circuit of *Full-Range Fahrenheit Temperature Sensor*; 6 Vdc for LM34 and LM34A for  $230^{\circ}F \le T_{J} \le 300^{\circ}F$ . These specifications also apply from 5°F to  $T_{MAX}$  in the circuit of *Basic Fahrenheit Temperature Sensor* (5°F to  $300^{\circ}F$ ).

PARAMETER		CONDITIONS	LM34		LM34C, LM34D			UNIT	
		CONDITIONS	MIN TYP	MAX	MIN	TYP	MAX	UNIT	
		Tested Limit		100			100		
	V <sub>S</sub> = 5 V, T <sub>A</sub> = 77°F	Design Limit						μΑ	
			75			75			
		Tested Limit							
	V <sub>S</sub> = 5 V	Design Limit		176			154	μA	
Quiescent current <sup>(6)</sup>			131			116			
Quiescent current**		Tested Limit		103			103		
	V <sub>S</sub> = 30 V, T <sub>A</sub> = 77°F	Design Limit						μA	
			76			76			
	V <sub>S</sub> = 30 V	Tested Limit						μA	
		Design Limit		181			159		
			132			117			
Change of quiescent current <sup>(5)</sup>	4 V $\leq$ V <sub>S</sub> $\leq$ 30 V, T <sub>A</sub> = +77°F	Tested Limit		3			3		
		Design Limit						μA	
			0.5			0.5			
	$5 V \le V_S \le 30 V$	Tested Limit							
		Design Limit		5			5	μA	
			1			116 103 76 159 117 0.5 1 0.5 1 0.5 1 0.7 0.3 5 3			
Temperature coefficient of quiescent current		Tested Limit							
		Design Limit		0.7			0.7	µA/°F	
			0.3			0.3			
	In circuit of Basic	Tested Limit							
Minimum temperature for rated accuracy	Fahrenheit Temperature Sensor	Design Limit		5.0			5	5 °F	
	(5°F to 300°F), $I_L = 0$		3			3			
Long-term stability	$T_J = T_{MAX}$ for 1000 hour	s	±0.16			±0.16		°F	

(6) Quiescent current is defined in the circuit of Basic Fahrenheit Temperature Sensor (5°F to 300°F).

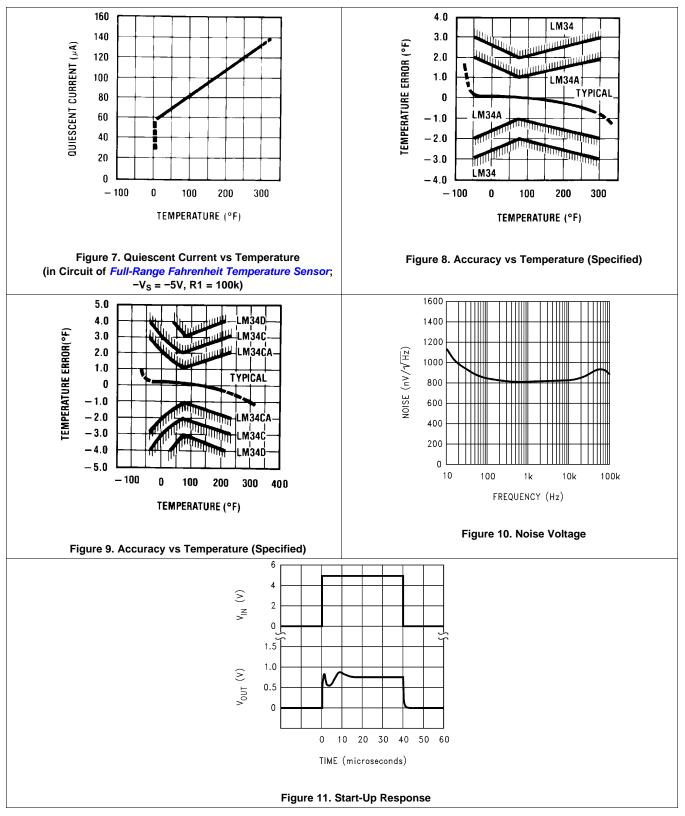


#### 6.7 Typical Characteristics





#### **Typical Characteristics (continued)**





#### 7 Detailed Description

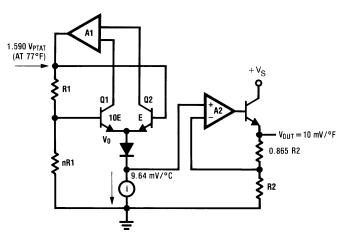
#### 7.1 Overview

The LM34 series devices are precision integrated-circuit temperature sensors, whose output voltage is linearly proportional to the Fahrenheit temperature. The LM34 device has an advantage over linear temperature sensors calibrated in degrees Kelvin, because the user is not required to subtract a large constant voltage from its output to obtain convenient Fahrenheit scaling. The LM34 device does not require any external calibration or trimming to provide typical accuracies of  $\pm 1/2^{\circ}F$  at room temperature and  $\pm 1-1/2^{\circ}F$  over a full  $-50^{\circ}F$  to  $300^{\circ}F$  temperature range. Lower cost is assured by trimming and calibration at the wafer level. The low output impedance, linear output, and precise inherent calibration of the LM34 device makes interfacing to readout or control circuitry especially easy. It can be used with single power supplies or with plus and minus supplies. Because the LM34 device draws only 75 µA from its supply, the device has very low self-heating, less than 0.2°F in still air.

The temperature sensing element is comprised of a simple base emitter junction that is forward biased by a current source. The temperature sensing element is buffered by an amplifier and provided to the OUT pin. The amplifier has a simple class-A output stage thus providing a low impedance output that can source 16  $\mu$ A and sink 1  $\mu$ A.

The temperature sensing element is comprised of a delta- $V_{BE}$  architecture. The temperature sensing element is then buffered by an amplifier and provided to the  $V_{OUT}$  pin. The amplifier has a simple class A output stage with typical 0.5- $\Omega$  output impedance as shown in the *Functional Block Diagram*. Therefore, the LM34 device can only source current and the sinking capability of the device is limited to 1  $\mu$ A.

#### 7.2 Functional Block Diagram



#### 7.3 Feature Description

#### 7.3.1 Capacitive Drive Capability

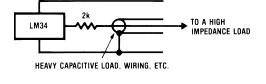
Like most micropower circuits, the LM34 device has a limited ability to drive heavy capacitive loads. The LM34 device, by itself, is able to drive 50 pF without special precautions. If heavier loads are anticipated, it is easy to isolate or decouple the load with a resistor; see Figure 12. You can improve the tolerance of capacitance with a series R-C damper from output to ground; see Figure 13. When the LM34 is applied with a 499- $\Omega$  load resistor (as shown Figure 18 and Figure 19), the device is relatively immune to wiring capacitance because the capacitance forms a bypass from ground to input, not on the output. However, as with any linear circuit connected to wires in a hostile environment, its performance can be affected adversely by intense electromagnetic sources such as relays, radio transmitters, motors with arcing brushes, transients of the SCR, and so on, as the wiring of the device can act as a receiving antenna and the internal junctions can act as rectifiers. For best results in such cases, a bypass capacitor from VIN to ground and a series R-C damper, such as 75  $\Omega$  in series with 0.2 µF or 1 µF from output to ground, are often useful. See Figure 23, Figure 24 and Figure 26 for more details.

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(1)

#### Feature Description (continued)



## Figure 12. LM34 With Decoupling from Capacitive Load

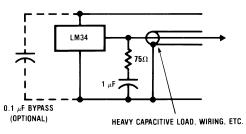


Figure 13. LM34 With R-C Damper

#### 7.3.2 LM34 Transfer Function

The accuracy specifications of the LM34 devices are given with respect to a simple linear transfer function shown in Equation 1:

VOUT = 10 mV/ $^{\circ}F \times T ^{\circ}F$ 

where

- V<sub>OUT</sub> is the LM34 output voltage
- T is the temperature in °F

#### 7.4 Device Functional Modes

The only functional mode of the LM34 device is that it has an analog output directly proportional to temperature.



#### 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 8.1 Application Information

The features of the LM34 device make it suitable for many general temperature sensing applications. Multiple package options expand on flexibility of the device.

#### 8.2 Typical Application

#### 8.2.1 Basic Fahrenheit Temperature Sensor Application

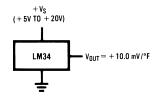


Figure 14. Basic Fahrenheit Temperature Sensor (5°F to 300°F)

#### 8.2.1.1 Design Requirements

PARAMETER	VALUE								
Accuracy at 77°F	±2°F								
Accuracy from -50°F to 300°F	±3°F								
Temperature Slope	10 mV/°F								

**Table 1. Key Requirements** 

#### 8.2.1.2 Detailed Design Procedure

Because the LM34 is a simple temperature sensor that provides an analog output, design requirements related to layout are more important than electrical requirements (see *Layout*).

#### 8.2.1.3 Application Curve

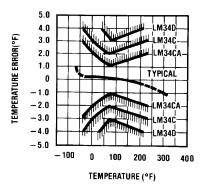
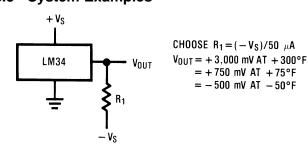
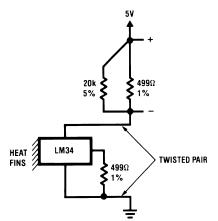


Figure 15. Temperature Error

### 8.3 System Examples







 $V_{OUT} = 10 \text{ mV/}^{\circ}\text{F} (T_A+3^{\circ}\text{F}) \text{ from } 3^{\circ}\text{F} \text{ to } 100^{\circ}\text{F}$ 



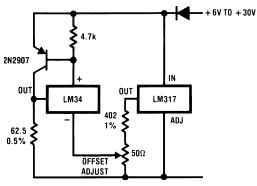
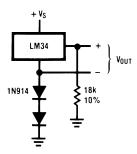
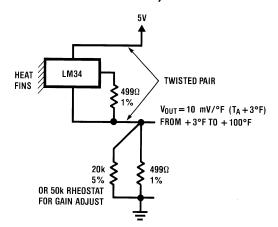


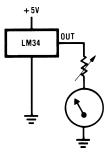
Figure 20. 4- to -20 mA Current Source (0°F to 100°F)















#### System Examples (continued)

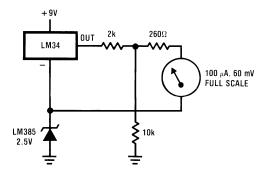
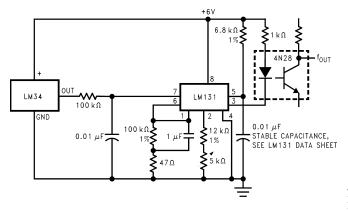


Figure 22. Expanded Scale Thermometer (50°F to 80°F, for Example Shown)



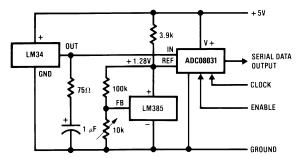


Figure 23. Temperature-to-Digital Converter (Serial Output, 128°F Full Scale)

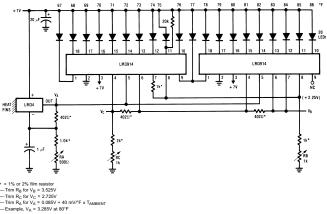


Figure 24. LM34 With Voltage-to-Frequency Converter and Isolated Output (3°F to 300°F; 30 Hz to 3000 Hz)

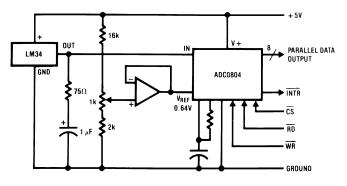


Figure 26. Temperature-to-Digital Converter (Parallel TRI-STATE Outputs for Standard Data Bus to µP Interface, 128°F Full Scale)

## Figure 25. Bar-Graph Temperature Display (Dot Mode)

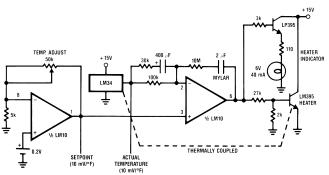


Figure 27. Temperature Controller



#### 9 Power Supply Recommendations

It may be necessary to add a bypass filter capacitor in noisy environments, as shown in as shown in Figure 13.

#### 10 Layout

#### 10.1 Layout Guidelines

The LM34 device can be easily applied in the same way as other integrated-circuit temperature sensors. The device can be glued or cemented to a surface and its temperature will be within about 0.02°F of the surface temperature. This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature of the LM34 die would be at an intermediate temperature between the surface temperature and the air temperature. This is especially true for the TO-92 plastic package, where the copper leads are the principal thermal path to carry heat into the device, so its temperature might be closer to the air temperature than to the surface temperature.

To minimize this problem, be sure that the wiring to the LM34, as it leaves the device, is held at the same temperature as the surface of interest. The easiest way to do this is to cover up these wires with a bead of epoxy, which will insure that the leads and wires are all at the same temperature as the surface, and that the die temperature of the LM34 device will not be affected by the air temperature.

The TO-46 metal package can be soldered to a metal surface or pipe without damage. In the case where soldering is used, the V- terminal of the circuit will be grounded to that metal. Alternatively, the LM34 device can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM34 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as a conformal coating and epoxy paints or dips are often used to insure that moisture cannot corrode the LM34 or its connections.

These devices are sometimes soldered to a small, light-weight heat fin to decrease the thermal time constant and speed up the response in slowly-moving air. On the other hand, a small thermal mass may be added to the sensor to give the steadiest reading despite small deviations in the air temperature.

CONDITIONS	TO-46 NO HEAT SINK	TO-46, SMALL HEAT Fin <sup>(1)</sup>	TO-92, NO HEAT SINK	TO-92, SMALL HEAT Fin <sup>(2)</sup>	SO-8 NO HEAT SINK	SO-8 SMALL HEAT Fin	
Still air	720°F/W	180°F/W	324°F/W	252°F/W	400°F/W	200°F/W	
Moving air	180°F/W	72°F/W	162°F/W	126°F/W	190°F/W	160°F/W	
Still oil	180°F/W	72°F/W	162°F/W	126°F/W	—	—	
Stirred oil	90°F/W	54°F/W	81°F/W	72°F/W	_	_	
(Clamped to metal, infinite heart sink)	(43°F	F/W )	_	_	(95°F/W )		

Table 2. Temperature Rise of LM34 Due to Self-Heating (Thermal Resistance)
--

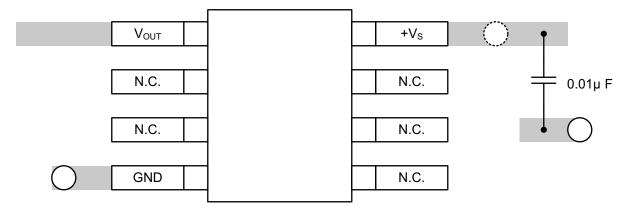
(1) Wakefield type 201 or 1-inch disc of 0.020-inch sheet brass, soldered to case, or similar.

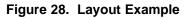
(2) TO-92 and SO-8 packages glued and leads soldered to 1-inch square of 1/16 inches printed circuit board with 2 oz copper foil, or similar.



#### 10.2 Layout Example









#### **11** Device and Documentation Support

#### 11.1 Trademarks

All trademarks are the property of their respective owners.

#### **11.2 Electrostatic Discharge Caution**



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 11.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

#### 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



#### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM34AH	ACTIVE	то	NDV	3	500	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	-45 to 148	( LM34AH, LM34AH)	Samples
LM34AH/NOPB	ACTIVE	то	NDV	3	500	RoHS & Green	Call TI	Level-1-NA-UNLIM	-45 to 148	( LM34AH, LM34AH)	Samples
LM34CAH	ACTIVE	то	NDV	3	500	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM34CAH, LM34CAH )	Samples
LM34CAH/NOPB	ACTIVE	то	NDV	3	500	RoHS & Green	Call TI	Level-1-NA-UNLIM	-40 to 110	(LM34CAH, LM34CAH )	Samples
LM34CAZ/NOPB	ACTIVE	TO-92	LP	3	1800	RoHS & Green	SN	N / A for Pkg Type	-40 to 110	LM34 CAZ	Samples
LM34CZ/NOPB	ACTIVE	TO-92	LP	3	1800	RoHS & Green	SN	N / A for Pkg Type	-40 to 110	LM34 CZ	Samples
LM34DH	ACTIVE	то	NDV	3	1000	Non-RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 100	( LM34DH, LM34DH)	Samples
LM34DH/NOPB	ACTIVE	то	NDV	3	1000	RoHS & Green	Call TI	Level-1-NA-UNLIM	0 to 100	(LM34DH, LM34DH)	Samples
LM34DM	NRND	SOIC	D	8	95	Non-RoHS & Green	Call TI	Level-1-235C-UNLIM	0 to 100	LM34D M	
LM34DM/NOPB	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	0 to 100	LM34D M	
LM34DMX/NOPB	ACTIVE	SOIC	D	8	2500	RoHS & Green	SN	Level-1-260C-UNLIM	0 to 100	LM34D M	Samples
LM34DZ/LFT7	ACTIVE	TO-92	LP	3	2000	RoHS & Green	SN	N / A for Pkg Type		LM34 DZ	Samples
LM34DZ/NOPB	ACTIVE	TO-92	LP	3	1800	RoHS & Green	SN	N / A for Pkg Type	0 to 100	LM34 DZ	Samples

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM34DMX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1



### PACKAGE MATERIALS INFORMATION

20-Feb-2024



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM34DMX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

#### TEXAS INSTRUMENTS

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#### TUBE



#### - B - Alignment groove width

\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
LM34DM	D	SOIC	8	95	495	8	4064	3.05
LM34DM	D	SOIC	8	95	495	8	4064	3.05

### D0008A



### **PACKAGE OUTLINE**

#### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



### D0008A

## **EXAMPLE BOARD LAYOUT**

### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



### D0008A

## **EXAMPLE STENCIL DESIGN**

### SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



### **GENERIC PACKAGE VIEW**

# TO-92 - 5.34 mm max height TRANSISTOR OUTLINE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



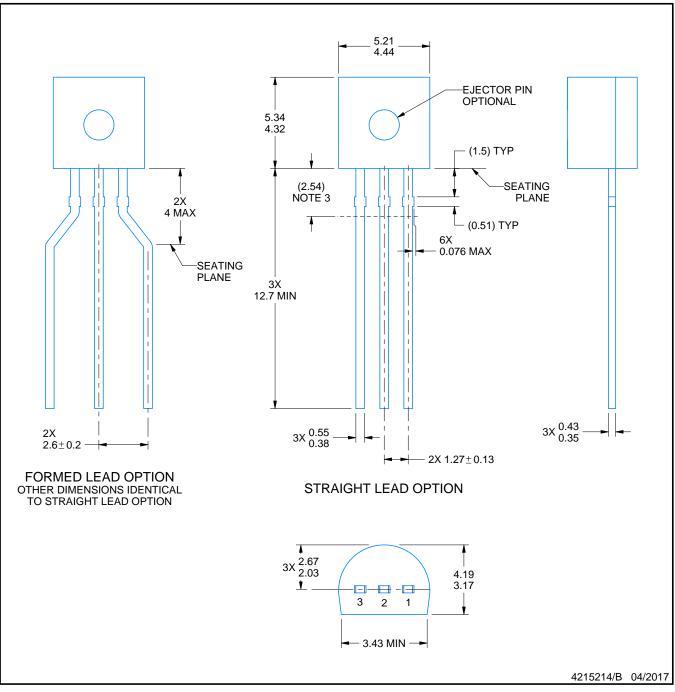
## LP0003A



### **PACKAGE OUTLINE**

### TO-92 - 5.34 mm max height

TO-92



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- Lead dimensions are not controlled within this area.
   Reference JEDEC TO-226, variation AA.
- 5. Shipping method:

  - a. Straight lead option available in bulk pack only.b. Formed lead option available in tape and reel or ammo pack.
  - c. Specific products can be offered in limited combinations of shipping medium and lead options.
  - d. Consult product folder for more information on available options.



### LP0003A

### **EXAMPLE BOARD LAYOUT**

### TO-92 - 5.34 mm max height

TO-92





## LP0003A

## TAPE SPECIFICATIONS

### TO-92 - 5.34 mm max height

TO-92





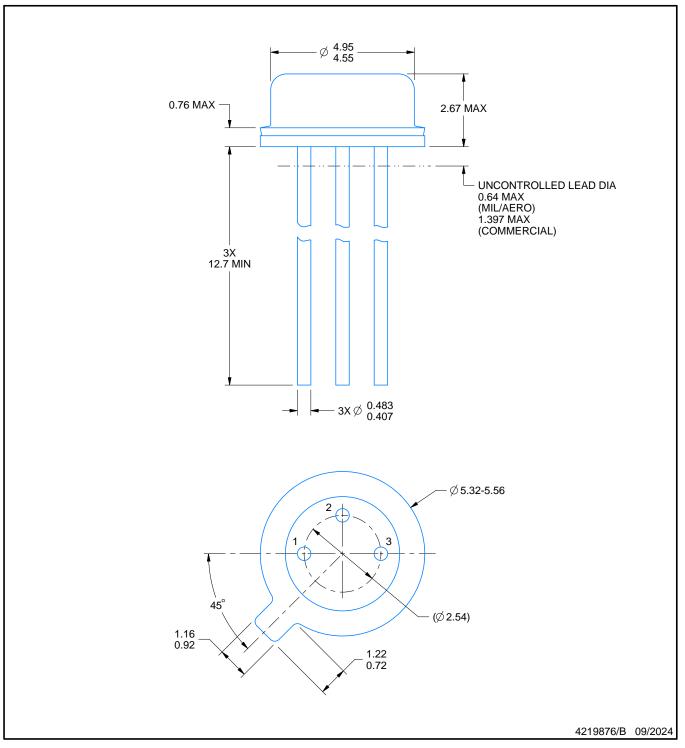
### **NDV0003H**



### **PACKAGE OUTLINE**

### TO-CAN - 2.67 mm max height

TRANSISTOR OUTLINE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing All linear dimensions are in minimeters. Any dime per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC registration TO-46.

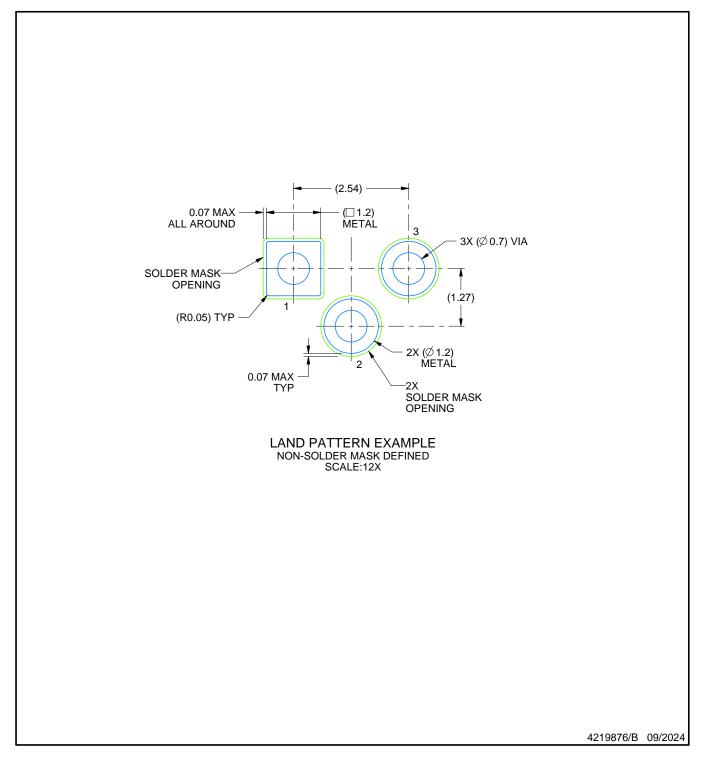


### NDV0003H

## **EXAMPLE BOARD LAYOUT**

### TO-CAN - 2.67 mm max height

TRANSISTOR OUTLINE





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